FAIRCHILD

SEMICONDUCTOR®

FDB8443

N-Channel PowerTrench[®] MOSFET

40V, 80A, $3.0m\Omega$

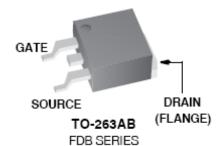
Features

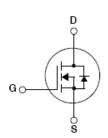
- Typ $r_{DS(on)}$ = 2.3m Ω at V_{GS} = 10V, I_D = 80A
- Typ Q_{g(10)} = 142nC at V_{GS} = 10V
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- Qualified to AEC Q101
- RoHS Compliant

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter / Alternator
- Distributed Power Architecture and VRMs
- Primary Switch for 12V Systems







August 2007

MOSF	ET Maximum Ratings T _C = 25°C unless otherwise noted			
Symbol	Parameter		Ratings	Units
V _{DSS}	Drain to Source Voltage		40	V
V _{GS}	Gate to Source Voltage		±20	V
	Drain Current Continuous (T _C < 146 ^o C, V _{GS} = 10V)		80	
I _D	Continuous (T_{amb} = 25°C, V_{GS} = 10V, with $R_{\theta JA}$ = 43°C/W)		25	А
	Pulsed		See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (N	ote 1)	531	mJ
D	Power Dissipation		188	W
P _D	Derate above 25°C		1.25	W/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to +175	°C

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance Junction to Case	0.8	°C/W
R_{\thetaJA}	Thermal Resistance Junction to Ambient (Note	2) 62	°C/W
$R_{ hetaJA}$	Thermal Resistance Junction to Ambient TO-263, 1in ² copper pad area	43	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8443	FDB8443	TO-263AB	330mm	24mm	800 units

Electrical Characteristics T_{C} = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
·						

Off Characteristics

B _{VDSS}	Drain to Source Breakdown Voltage	I_D = 250 μ A, V_{GS}	I _D = 250μA, V _{GS} = 0V		-	-	V
	Zara Cata Valtaga Drain Current	V _{DS} = 32V,		-	-	1	۸
I _{DSS} Zero Gate Voltage Drain Current	$V_{GS} = 0V$	T _C = 150 ^o C	-	-	250	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$	V _{GS} = ±20V		-	±100	nA

On Characteristics

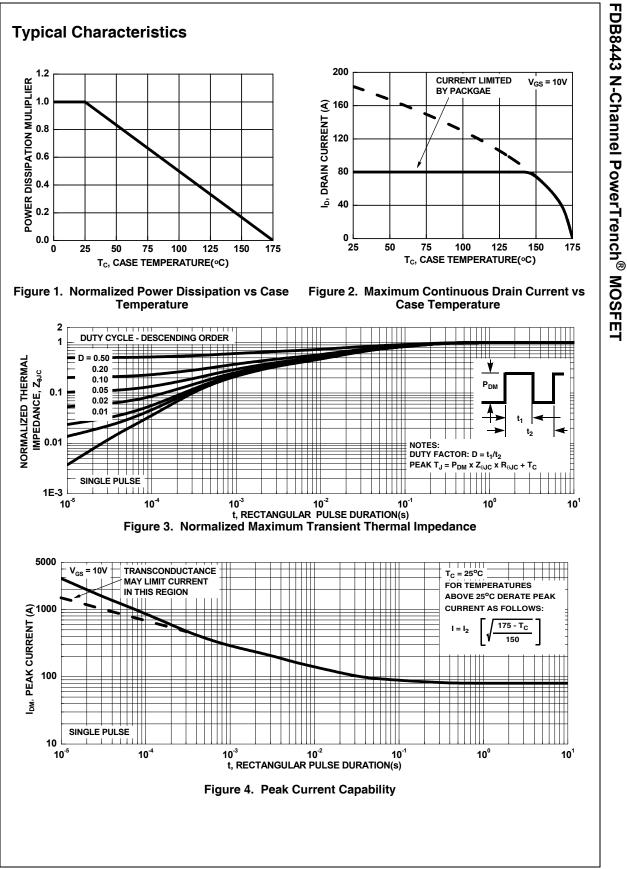
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2	2.8	4	V
		I _D = 80A, V _{GS} = 10V	-	2.3	3.0	
r _{DS(on)}	Drain to Source On Resistance	I _D = 80A, V _{GS} = 10V, T _J = 175°C	-	4.2	5.5	mΩ

Dynamic Characteristics

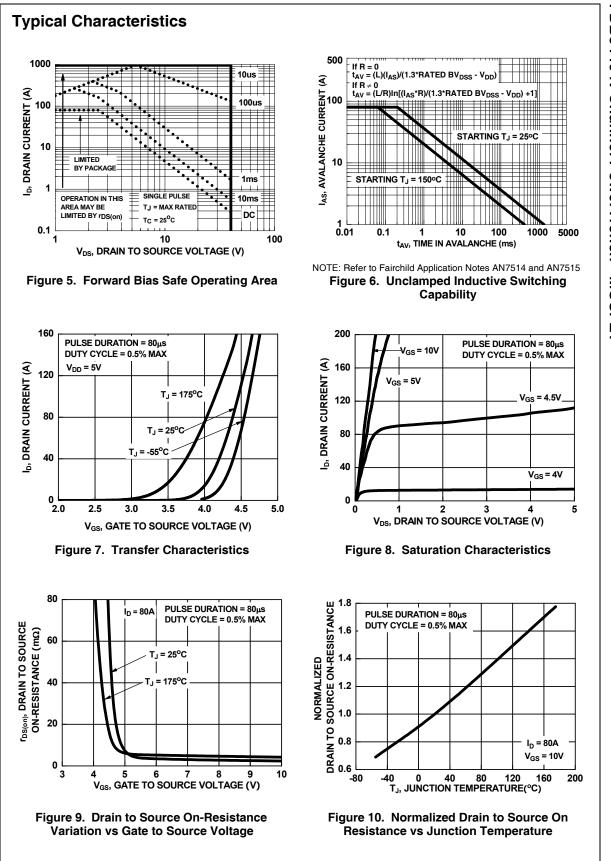
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	9310	-	pF
C _{oss}	Output Capacitance			-	800	-	pF
C _{rss}	Reverse Transfer Capacitance			-	510	-	pF
R _G	Gate Resistance	V _{GS} = 0.5V, f = 1N	1Hz	-	0.9	-	Ω
Q _{g(TOT)}	Total Gate Charge at 10V	V _{GS} = 0 to 10V		-	142	185	nC
Q _{g(TH)}	Threshold Gate Charge	V_{GS} = 0 to 2V	V _{DD} = 20V	-	17.5	23	nC
Q _{gs}	Gate to Source Gate Charge		I _D = 35A	-	36	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		l _g = 1mA	-	18.8	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	32	-	nC

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Switch	ning Characteristics (V _{GS}	= 10V)				
t _{on}	Turn-On Time		-	-	58	ns
t _{d(on)}	Turn-On Delay Time		-	18.4	-	ns
t _r	Rise Time	$V_{DD} = 20V, I_D = 35A$	-	17.9	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, R _{GS} = 2Ω	-	55	-	ns
t _f	Fall Time		-	13.5	-	ns
t _{off}	Turn-Off Time		-	-	109	ns
t	Reverse Recovery Time	ISD - IOA				ns
Drain-S	ource Diode Characteristics					
V _{SD}		I _{SD} = 15A	-	0.8	1.0	
	-	I _{SD} = 35A, dI _{SD} /dt = 100A/μs	-			ns
Q _{rr}	Reverse Recovery Charge		-	48	62	nC
t _{rr} Q _{rr} Notes: 1: Starting T 2: Pulse widt	Reverse Recovery Time Reverse Recovery Charge = 25°C, L = 0.26mH, I _{AS} = 64A. h = 100s.	I _{SD} = 35A, dI _{SD} /dt = 100A/μs	-	42 48	55 62	

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/ All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

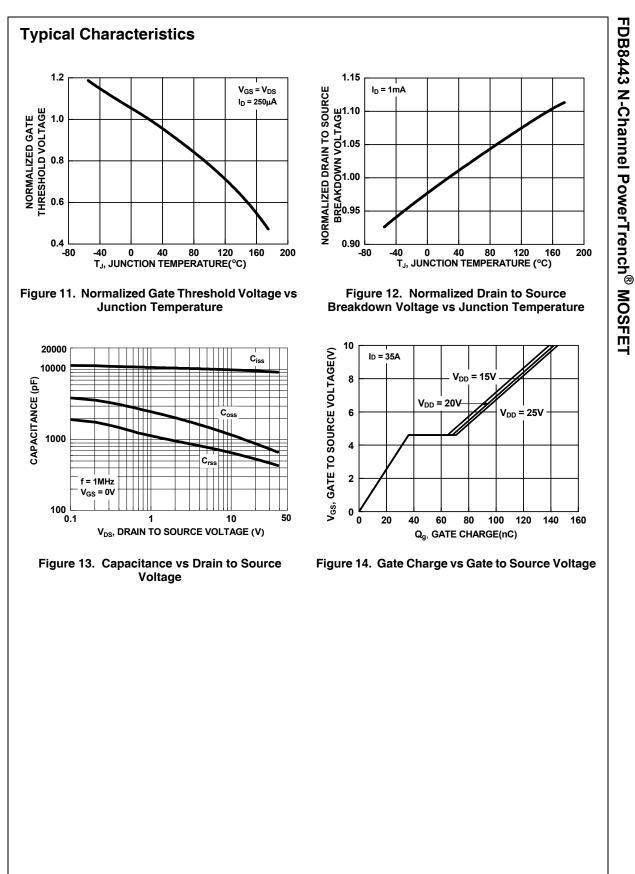


FDB8443 Rev. A



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Preliminary First Production		This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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